

IN THE CLAIMS:

Please cancel Claim 21, and amend Claims 23-26, 28-36, and 55 as

1.-22. (Cancelled)

23. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim ~~21~~ 55, wherein the wavelength converting member comprises a fluorescent member.

24. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim ~~21~~ 55, wherein the conductive member comprises an insulating base and a conductive layer provided thereon.

25. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim ~~21~~ 55, wherein the conductive member comprises a metal.

26. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim 25, wherein the metal comprises aluminum.

27. (Cancelled)

28. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim ~~21~~ 55, wherein an area of the conductive member overlaps said photoelectric conversion elements.

29. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim ~~21~~ 55, wherein a periphery of the conductive member is sealed.

30. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim ~~21~~ 55, wherein a periphery of the conductive member extends over the outer edges of the and an edge portion of said conductive member is sealed so as to cover the outer edges of the plurality of substrates.

31. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim 30, wherein a space is formed between the outer edges of said plurality of substrates and the conductive member.

32. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim 30, wherein said outer edges of said plurality of substrates and the conductive member are in close contact with each other.

33. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim 31, wherein a resin is provided in the space.

34. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim ~~21~~ 55, wherein a resin is provided which covers said plurality of substrates and all the end faces of the conductive member.

35. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim ~~21~~ 55, wherein the plurality of photoelectric conversion elements are arranged in a matrix.

36. (Currently Amended) The ~~photoelectric conversion device~~ imaging apparatus according to Claim 26, wherein the metal has a thickness of 100 μm or less.

37. - 54. (Cancelled)

55. (Currently Amended) An imaging apparatus comprising, the photoelectric conversion device ~~imaging apparatus according to claim 21,~~

a photoelectric conversion device having a conductive member, a plurality of substrates each having a plurality of photoelectric conversion elements, the plurality of substrates being arranged adjacent each other in a plane, and a wavelength converting member disposed between the photoelectric conversion elements and the a conductive member, stacked and arranged on the photoelectric conversion elements over the plurality of substrates wherein said conductive member is grounded;

a control circuit for driving the device; and

~~an apparatus body including a housing for~~ said photoelectric device and said control circuit, wherein said conductive member is disposed between said housing and said wavelength converting member.